## NSN 5962-01-358-1169

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-01-358-1169 **Body Length:** 0.955 inches **Body Width:** 0.955 inches **Body Height:** 0.116 inches **Maximum Power Dissipation Rating:** 1.5 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Burn in and bidirectional and monolithic **Inclosure Material:** Ceramic **Inclosure Configuration:** Can **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 55 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: -0.5 volts power source and 7.0 volts power source **Memory Device Type:** Pal **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 68 pin Shelf Life: N/a **Unit Of Measure: Demilitarization:** Yes - demil/mli

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